

# ISL84524, ISL84525

Low-Voltage, Single Supply, 4 to 1 Multiplexer and DPDT Analog Switches

FN6042 Rev 3.00 February 24, 2012

The Intersil ISL84524 and ISL84525 devices are precision, bidirectional, analog switches configured as a 4 channel multiplexer/demultiplexer (ISL84524) and a double pole/double throw (DPDT) switch (ISL84525) designed to operate from a single +2V to +12V supply. Both have an inhibit pin to simultaneously open all signal paths.

ON resistance is  $200\Omega$  with a +5V supply and  $500\Omega$  with a +3V supply. Each switch can handle rail-to-rail analog signals. The off-leakage current is only 1nA at +25°C or 25nA at +85°C.

All digital inputs have 0.8V to 2.4V logic thresholds, ensuring TTL/CMOS logic compatibility when using a single +5V supply.

The ISL84524 is a 4 to 1 multiplexer device. The ISL84525 is a DPDT, which is perfect for use in 2-to-1 multiplexer applications.

Table 1 summarizes the performance of this family. For higher performance, see the <u>ISL43640</u> and <u>ISL43410</u> data sheets.

**TABLE 1. FEATURES AT A GLANCE** 

R <sub>ON</sub> AND t <sub>ON</sub> /t <sub>OFF</sub>	ISL84524 4:1 MUX	ISL84525 DPDT		
3V R <sub>ON</sub>	190Ω	190Ω		
3V t <sub>ON</sub> /t <sub>OFF</sub>	170ns/50ns	170ns/50ns		
5V R <sub>ON</sub>	92Ω 92Ω			
5V t <sub>ON</sub> /t <sub>OFF</sub>	90ns/40ns 90ns/40ns			
PACKAGE	10 Ld MSOP			

### Related Literature

- Technical Brief <u>TB363</u> "Guidelines for Handling and Processing Moisture Sensitive Surface Mount Devices (SMDs)"
- Application Note <u>AN557</u> "Recommended Test Procedures for Analog Switches"

#### **Features**

Drop-in Replacements for MAX4524 and MAX4525
• ON Resistance (R <sub>ON</sub> ) Max, V <sub>S</sub> = 5V
• ON Resistance (R <sub>ON</sub> ) Max, V <sub>S</sub> = 3V
R <sub>ON</sub> Matching Between Channels
Low Charge Injection 5pC (Max)
Single Supply Operation +2V to +12V
• Low Power Consumption (PD)
• Fast Switching Action (V <sub>S</sub> = 5V)
- t <sub>ON</sub>
- t <sub>OFF</sub> 40ns
Guaranteed Max Off-leakage @ 5V 25nA

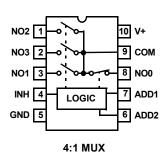
- · Guaranteed Break-Before-Make
- · TTL, CMOS Compatible
- · Available in 10 Ld MSOP Package
- · Pb-free available

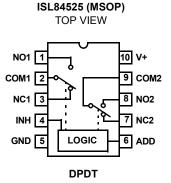
# **Applications**

- · Battery Powered, Handheld, and Portable Equipment
- · Communications Systems
  - Radios
  - Telecom Infrastructure
  - ADSL, VDSL Modems
- · Test Equipment
  - Medical Ultrasound
  - Magnetic Resonance Image
  - CT and PET Scanners
  - ATE
  - Electrocardiograph
- · Audio and Video Signal Routing
- · Various Circuits
  - +3V/+5V DACs and ADCs
  - Sample and Hold Circuits
  - Operational Amplifier Gain Switching Networks
  - High Frequency Analog Switching
  - High Speed Multiplexing
  - Integrator Reset Circuits

# Pinouts (Note 1)

#### ISL84524 (MSOP) TOP VIEW





#### NOTE:

1. Switches Shown for Logic "0" Inputs.

## **Truth Tables**

ISL84524								
INH	INH ADD2 ADD1 SWITCH ON							
1	Х	Х	NONE					
0	0	0	NO0					
0	0	1	NO1					
0	1	0	NO2					
0	1 1 NO3							
	ISL	.84525						
INH	ΑI	DD	SWITCH ON					
1	Х		NONE					
0	0		NCX					
0	,	1	NOX					

NOTE: Logic "0"  $\leq\!0.8V.$  Logic "1"  $\geq\!2.4V,$  with  $V_{\mbox{\scriptsize S}}$  between 3V and 11V.

# **Pin Descriptions**

PIN	FUNCTION
V+	System Power Supply Input (+2V to +12V)
GND	Ground Connection
INH	Digital Control Input. Connect to GND for Normal Operation. Connect to V+ to turn all switches off.
COM	Analog Switch Common Pin
NOX	Analog Switch Normally Open Pin
NCX	Analog Switch Normally Closed Pin
ADDX	Address Input Pin

# Ordering Information

PART # (Notes 2, 3, 4)	PART MARKING	TEMP. RANGE (°C)	PACKAGE (Pb-free)	PKG. DWG.#
ISL84524IUZ	4524Z	-40 to 85	10 Ld MSOP	M10.118
ISL84525IUZ	4525Z	-40 to 85	10 Ld MSOP	M10.118

#### NOTES:

- Add "-T\*" suffix for tape and reel. Please refer to <u>TB347</u> for details on reel specifications.
- 3. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- For Moisture Sensitivity Level (MSL), please see device information page for <u>ISL84524</u>, <u>ISL84525</u>. For more information on MSL please see tech brief <u>TB363</u>.

# Absolute Maximum Ratings V+ to GND -0.3 to 15V Input Voltages INH, NO, NC, ADD (Note 5) -0.3 to ((V+) + 0.3V) Output Voltages COM (Note 5) -0.3 to ((V+) + 0.3V) Continuous Current (Any Terminal) 20mA Peak Current NO, NC, or COM (Pulsed 1ms, 10% Duty Cycle, Max) 40mA

#### Thermal Information

Thermal Resistance (Typical, Note 6)	$\theta_{JA}$ (°C/W)
10 Ld MSOP Package	. 190
Maximum Junction Temperature (Plastic Package)	+150°C
Moisture Sensitivity (See Technical Brief TB363)	
10 Ld MSOP Package	Level 1
Maximum Storage Temperature Range	65°C to +150°C
Pb-Free Reflow Profile	.see link below
http://www.intersil.com/pbfree/Pb-FreeReflow.asp	

### **Operating Conditions**

Temperature Range ISL8452XIUZ .....-40°C to +85°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### NOTES:

- 5. Signals on NC, NO, COM, ADD, or INH exceeding V+ or GND are clamped by internal diodes. Limit forward diode current to maximum current ratings.
- 6. θ<sub>JA</sub> is measured with the component mounted on a low effective thermal conductivity test board in free air. See Tech Brief <u>TB379</u> for details.

**Electrical Specifications** +5V Supply Test Conditions: V+ = +4.5V to +5.5V, GND = 0V,  $V_{INH} = 2.4V$ ,  $V_{INL} = 0.8V$  (Note 7), unless otherwise specified. **Boldface limits apply over the operating temperature range, -40°C to +85°C.** 

PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN (Notes 8, 9)	TYP	MAX (Notes 8, 9)	UNITS
ANALOG SWITCH CHARACTERIS	STICS	Į.	"		11	
Analog Signal Range, V <sub>ANALOG</sub>		Full	0	-	V+	V
ON Resistance, R <sub>ON</sub>	V+ = 4.5V, I <sub>COM</sub> = 1.0mA, V <sub>NO</sub> or V <sub>NC</sub> = 3.5V	25	-	-	150	Ω
	(See Figure 5)	Full	-	-	200	Ω
R <sub>ON</sub> Matching Between Channels,	V+ = 4.5V, I <sub>COM</sub> = 1.0mA, V <sub>NO</sub> or V <sub>NC</sub> = 3.5V (Note 11)	25	-	2	8	Ω
$\Delta R_{ON}$		Full	-	-	15	Ω
R <sub>ON</sub> Flatness, R <sub>FLAT(ON)</sub>	V+ = 5.5V, I <sub>COM</sub> = 1.0mA, V <sub>NO</sub> or V <sub>NC</sub> = 1.5V, 2.5V, 3.5V (Note 12)	Full	-	-	15.5	Ω
NO or NC OFF Leakage Current,	V+ = 5.5V, V <sub>COM</sub> = 1V, 4.5V, V <sub>NO</sub> or V <sub>NC</sub> = 4.5V, 1V (Note 10)	25	-1	-	1	nA
I <sub>NO(OFF)</sub> or I <sub>NC(OFF)</sub>		Full	-10	-	10	nA
COM OFF Leakage Current,	$V+ = 5.5V$ , $V_{COM} = 4.5V$ , $1V$ , $V_{NO}$ or $V_{NC} = 1V$ , $4.5V$ (Note 10)	25	-1	-	1	nA
ICOM(OFF)		Full	-25	-	25	nA
COM ON Leakage Current,	$V = 5.5V$ , $V_{COM} = 1V$ , 4.5V, or $V_{NO}$ or $V_{NC} = 1V$ , 4.5V,	25	-1	-	1	nA
ICOM(ON)	or Floating (Note 10)		-25	-	25	nA
DIGITAL INPUT CHARACTERISTIC	cs		1		1	
Input Voltage High, V <sub>INH</sub>		Full	2.4	1.5	-	V
Input Voltage Low, V <sub>INL</sub>		Full	-	1.5	0.8	٧
Input Current, I <sub>INH</sub> , I <sub>INL</sub>	V+ = 5.5V, V <sub>IN</sub> = 0V or V+	Full	-1	-	1	μΑ
DYNAMIC CHARACTERISTICS		Į.	1		1	
Inhibit Turn-ON Time, t <sub>ON</sub>	$V_{NO}$ or $V_{NC}$ = 3V, $R_L$ = 300 $\Omega$ , $C_L$ = 35pF, $V_{IN}$ = 0 to 3 (See Figure 1)	25	-	90	150	ns
		Full	-	-	200	ns
Inhibit Turn-OFF Time, t <sub>OFF</sub>	$V_{NO}$ or $V_{NC}$ = 3V, $R_L$ = 300 $\Omega$ , $C_L$ = 35pF, $V_{IN}$ = 0 to 3	25	-	40	120	ns
	(See Figure 1)		-	-	180	ns



**Electrical Specifications** +5V Supply Test Conditions: V + = +4.5V to +5.5V, GND = 0V,  $V_{INH} = 2.4V$ ,  $V_{INL} = 0.8V$  (Note 7), unless otherwise specified. **Boldface limits apply over the operating temperature range**, -40°C to +85°C. (Continued)

PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN (Notes 8, 9)	TYP	MAX (Notes 8, 9)	UNITS
Address Transition Time, t <sub>TRANS</sub>	$V_{NO}$ or $V_{NC}$ = 3V, $R_L$ = 300 $\Omega$ , $C_L$ = 35pF,		-	90	150	ns
	V <sub>IN</sub> = 0 to 3 (See Figure 1)	Full	-	-	200	ns
Break-Before-Make Time Delay, t <sub>D</sub>	$R_L$ = 300 $\Omega$ , $C_L$ = 35pF, $V_{NO}$ = $V_{NC}$ = 3V, $V_{IN}$ = 0 to 3 (See Figure 3)	25	5	20	-	ns
Charge Injection, Q	$C_L$ = 1.0nF, $V_G$ = 0V, $R_G$ = 0 $\Omega$ (See Figure 2)	25	-	8.0	5	рС
OFF Isolation	$R_L = 50\Omega$ , $C_L = 5pF$ , $f = 1MHz$ (See Figure 4)	25	-	75	-	dB
Crosstalk (Channel-to-Channel), (ISL84525)	$R_L = 50\Omega$ , $C_L = 5pF$ , $f = 1MHz$ (See Figure 6)	25	-	-85	-	dB
NO or NC OFF Capacitance, COFF	f = 1MHz, V <sub>NO</sub> or V <sub>NC</sub> = V <sub>COM</sub> = 0V (See Figure 7)	25	-	4	-	pF
COM OFF Capacitance, C <sub>COM(OFF)</sub>	f = 1MHz, $V_{NO}$ or $V_{NC}$ = $V_{COM}$ = 0V (See Figure 7) ISL84524	25	-	14	-	pF
	f = 1MHz, $V_{NO}$ or $V_{NC}$ = $V_{COM}$ = 0V (See Figure 7) ISL84525	25	-	6	-	pF
COM ON Capacitance, C <sub>COM(ON)</sub>	f = 1MHz, V <sub>NO</sub> or V <sub>NC</sub> = V <sub>COM</sub> = 0V (See Figure 7) ISL84524	25	-	20	-	pF
	f = 1MHz, $V_{NO}$ or $V_{NC} = V_{COM} = 0V$ (See Figure 7) ISL84525	25	-	12	-	pF
POWER SUPPLY CHARACTERISTI	cs		1			
Power Supply Range		Full	2	-	12	V
Positive Supply Current, I+	V+ = 5.5V, V <sub>IN</sub> = 0V or V+, all channels on or off	25	-1	-	1	μΑ
		Full	-10	-	10	μΑ

#### NOTES:

- 7. V<sub>IN</sub> = input voltage to perform proper function.
- 8. The algebraic convention, whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- 9. Compliance to datasheet limits is assured by one or more methods: production test, characterization and/or design.
- 10. Leakage parameter is 100% tested at high temp, and guaranteed by correlation at +25°C.
- 11.  $\Delta R_{ON} = R_{ON} (MAX) R_{ON} (MIN)$ .
- 12. Flatness is defined as the difference between maximum and minimum value of on-resistance over the specified analog signal range.

**Electrical Specifications** +3V Supply Test Conditions: V + = +2.7V to +3.6V, GND = 0V,  $V_{AH} = 2.4V$ ,  $V_{AL} = 0.8V$  (Note 7), unless otherwise specified. **Boldface limits apply over the operating temperature range, -40°C to +85°C.** 

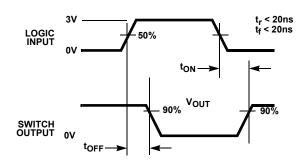
PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN (Note 8)	TYP	MAX (Note 8)	UNITS		
ANALOG SWITCH CHARACTERISTICS								
Analog Signal Range, V <sub>ANALOG</sub>		Full	0	-	V+	V		
ON Resistance, R <sub>ON</sub>	V+ = 2.7V, I <sub>COM</sub> = 1.0mA, V <sub>NO</sub> or V <sub>NC</sub> = 1.5V (See Figure 5)	25	-	-	400	Ω		
		Full	-	-	500	Ω		
NO or NC OFF Leakage Current, INO(OFF) OF INC(OFF)	V+ = 3.6V, V <sub>COM</sub> = 1V, 3V, V <sub>NO</sub> or V <sub>NC</sub> = 3V, 1V (Note 10)	25	-1	-	1	nA		
		Full	-10	-	10	nA		
COM OFF Leakage Current, ICOM(OFF)	V+ = 3.6V, V <sub>COM</sub> = 3V, 1V, V <sub>NO</sub> or V <sub>NC</sub> = 1V, 3V (Note 10)	25	-1	-	1	nA		
		Full	-25	-	25	nA		
COM ON Leakage Current, ICOM(ON)	$V+$ = 3.6V, $V_{COM}$ = 1V, 3V, or $V_{NO}$ or $V_{NC}$ = 1V, 3V, or floating (Note 10)	25	-1	-	1	nA		
		Full	-25	-	25	nA		



**Electrical Specifications** +3V Supply Test Conditions: V+ = +2.7V to +3.6V, GND = 0V,  $V_{AH} = 2.4V$ ,  $V_{AL} = 0.8V$  (Note 7), unless otherwise specified. **Boldface limits apply over the operating temperature range, -40°C to +85°C.** (Continued)

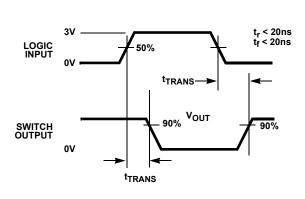
PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN (Note 8)	TYP	MAX (Note 8)	UNITS
DIGITAL INPUT CHARACTERISTIC	cs	· L				<u>l</u>
Input Voltage High, V <sub>INH</sub>		Full	2.0	1.0	-	V
Input Voltage Low, V <sub>INL</sub>		Full	-	1.0	0.5	V
Input Current, I <sub>INH</sub> , I <sub>INL</sub>	V+ = 3.6V, V <sub>IN</sub> = 0V or V+	Full	-1	-	1	μΑ
DYNAMIC CHARACTERISTICS					1	.1
Inhibit Turn-ON Time, t <sub>ON</sub>	$V_{NO}$ or $V_{NC}$ = 1.5V, $R_{L}$ = 300 $\Omega$ , $C_{L}$ = 35pF,	25	-	170	300	ns
	V <sub>IN</sub> = 0 to 3 (See Figure 1)	Full	-	-	400	ns
Inhibit Turn-OFF Time, t <sub>OFF</sub>	$V_{NO}$ or $V_{NC}$ = 1.5V, $R_{L}$ = 300 $\Omega$ , $C_{L}$ = 35pF,	25	-	50	200	ns
	V <sub>IN</sub> = 0 to 3 (See Figure 1)	Full	-	-	300	ns
Address Transition Time, t <sub>TRANS</sub>	$V_{NO}$ or $V_{NC}$ = 1.5V, $R_{L}$ = 300 $\Omega$ , $C_{L}$ = 35pF,	25	-	130	300	ns
	V <sub>IN</sub> = 0 to 3 (See Figure 1)	Full	-	-	400	ns
Break-Before-Make Time Delay, t <sub>D</sub>	$R_L$ = 300 $\Omega$ , $C_L$ = 35pF, $V_{NO}$ or $V_{NC}$ = 1.5V, $V_{IN}$ = 0 to 3 (See Figure 3)	Full	5	40	-	ns
Charge Injection, Q	$C_L = 1.0$ nF, $V_G = 0$ V, $R_G = 0\Omega$ (See Figure 2)	25	-	0.8	1	pC
OFF Isolation	$R_L = 50\Omega$ , $C_L = 5pF$ , $f = 1MHz$ (See Figure 4)	25	-	75	-	dB
Crosstalk (Channel-to-Channel)	$R_L = 50\Omega$ , $C_L = 5pF$ , $f = 1MHz$ (See Figure 6)	25	-	-85	-	dB
NO or NC OFF Capacitance, COFF	f = 1MHz, V <sub>NO</sub> or V <sub>NC</sub> = V <sub>COM</sub> = 0V (See Figure 7)	25	-	4	-	pF
COM OFF Capacitance, C <sub>COM(OFF)</sub>	f = 1MHz, V <sub>NO</sub> or V <sub>NC</sub> = V <sub>COM</sub> = 0V (See Figure 7) ISL84524	25	-	14	-	pF
	f = 1MHz, V <sub>NO</sub> or V <sub>NC</sub> = V <sub>COM</sub> = 0V (See Figure 7) ISL84525	25	-	6	-	pF
COM ON Capacitance, C <sub>COM(ON)</sub>	f = 1MHz, V <sub>NO</sub> or V <sub>NC</sub> = V <sub>COM</sub> = 0V (See Figure 7) ISL84524	25	-	20	-	pF
	f = 1MHz, V <sub>NO</sub> or V <sub>NC</sub> = V <sub>COM</sub> = 0V (See Figure 7) ISL84525	25	-	12	-	pF
POWER SUPPLY CHARACTERIST	rics	1			-	1
Positive Supply Current, I+	V+ = 3.6V, V <sub>IN</sub> = 0V or V+, all channels on or off	25	-1	-	1	μA
		Full	-10	-	10	μA

# **Test Circuits and Waveforms**

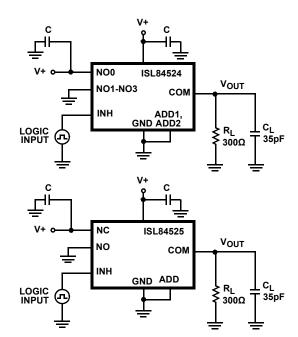


Logic input waveform is inverted for switches that have the opposite logic sense.

FIGURE 1A. INHIBIT MEASUREMENT POINTS



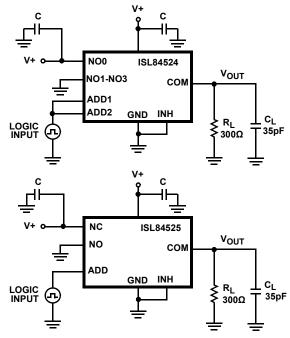
Logic input waveform is inverted for switches that have the opposite logic sense.



Repeat test for other switches.  $C_L$  includes fixture and stray capacitance.  $R_{\rm I}$ 

 $V_{OUT} = V_{(NO \text{ or NC})} \frac{\kappa_L}{R_L + R_{(ON)}}$ 

FIGURE 1B. INHIBIT TEST CIRCUIT



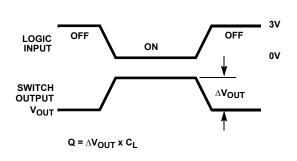
Repeat test for other switches. C<sub>L</sub> includes fixture and stray capacitance.

 $V_{OUT} = V_{(NO \text{ or NC})} \frac{R_L}{R_L + R_{(ON)}}$ 

FIGURE 1C. ADDRESS MEASUREMENT POINTS FIGURE 1D. ADDRESS TEST CIRCUIT

FIGURE 1. SWITCHING TIMES

# Test Circuits and Waveforms (Continued)



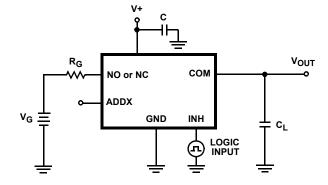


FIGURE 2A. MEASUREMENT POINTS

FIGURE 2B. TEST CIRCUIT

Vout

300Ω

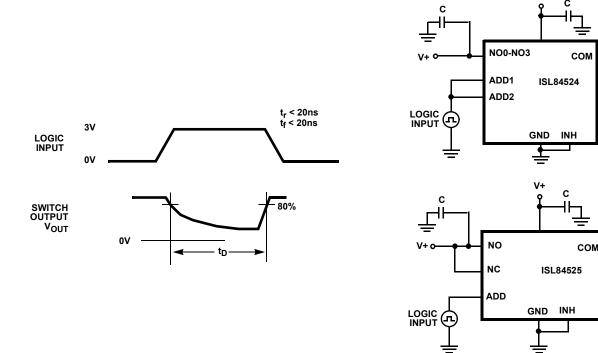
 $v_{\text{OUT}}$ 

 $\textbf{c}_{\textbf{L}}$ 

35pF

35pF

FIGURE 2. CHARGE INJECTION



Repeat test for other switches.  $C_L$  includes fixture and stray capacitance.

FIGURE 3A. MEASUREMENT POINTS

FIGURE 3B. TEST CIRCUIT

FIGURE 3. BREAK-BEFORE-MAKE TIME

# Test Circuits and Waveforms (Continued)

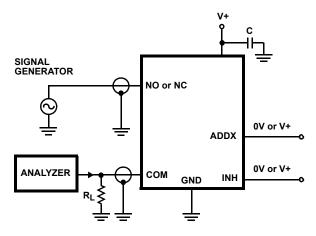


FIGURE 4. OFF ISOLATION TEST CIRCUIT

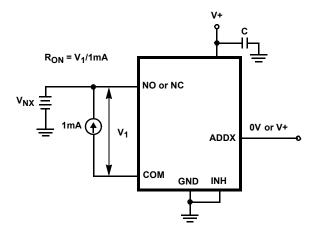


FIGURE 5. RON TEST CIRCUIT

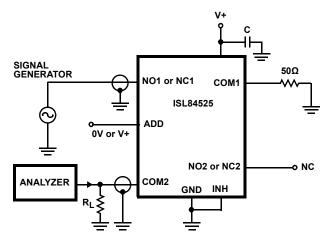


FIGURE 6. CROSSTALK TEST CIRCUIT

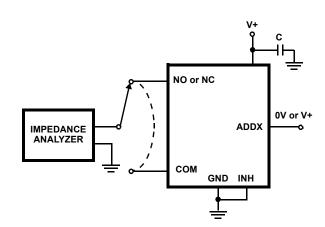


FIGURE 7. CAPACITANCE TEST CIRCUIT

# **Detailed Description**

The ISL84524 and ISL84525 operate from a single 2V to 12V supply with low on-resistance and high speed operation. The devices are especially well suited to portable battery powered equipment thanks to the low operating supply voltage (2.7V), low power consumption (3 $\mu$ W), low leakage currents (25nA max), and the tiny MSOP packaging. High frequency applications also benefit from the wide bandwidth, and the very high off isolation (75dB) and crosstalk rejection (-85dB).

#### Supply Sequencing and Overvoltage Protection

With any CMOS device, proper power supply sequencing is required to protect the device from excessive input currents which might permanently damage the IC. All I/O pins contain ESD protection diodes from the pin to V+ and to GND (see Figure 8). To prevent forward biasing these diodes, V+ must be applied before any input signals, and the input signal voltages must remain between V+ and GND.

If these conditions cannot be guaranteed, then precautions must be implemented to prohibit the current and voltage at the logic pin and signal pins from exceeding the maximum ratings of the switch. The following two methods can be used to provide additional protection to limit the current in the event that the voltage at a signal pin or logic pin goes below ground or above the V+ rail.

Logic inputs can be protected by adding a  $1k\Omega$  resistor in series with the logic input (see Figure 8). The resistor limits the input current below the threshold that produces permanent damage, and the sub-microamp input current produces an insignificant voltage drop during normal operation.

This method is not acceptable for the signal path inputs. Adding a series resistor to the switch input defeats the purpose of using a low  $R_{ON}$  switch. Connecting Schottky diodes to the signal pins (as shown in Figure 8) will shunt the fault current to the supply or to ground thereby protecting the switch. These Schottky diodes must be sized to handle the expected fault current.

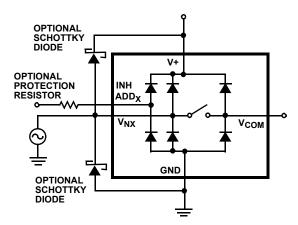


FIGURE 8. OVERVOLTAGE PROTECTION

#### **Power-Supply Considerations**

The ISL8452X construction is typical of most CMOS analog switches, except that they have only two supply pins: V+ and GND. V+ and GND drive the internal CMOS switches and set their analog voltage limits. Unlike switches with a 13V maximum supply voltage, the ISL8452X 15V maximum supply voltage provides plenty of room for the 10% tolerance of 12V supplies, as well as room for overshoot and noise spikes.

The minimum recommended supply voltage is 2V. It is important to note that the input signal range, switching times, and on-resistance degrade at lower supply voltages. Refer to the Electrical Specification tables (starting on page 3) and Typical Performance Curves (starting on page 10) for details.

V+ and GND also power the internal logic and level shifters. The level shifters convert the input logic levels to switched V+ and GND signals to drive the analog switch gate terminals.

This family of switches cannot be operated with bipolar supplies, because the input switching point becomes negative in this configuration.

#### Logic-Level Thresholds

This switch family is TTL compatible (0.8V and 2.4V) over a supply range of 2V to 11V. At 12V the  $V_{IH}$  level is about 2.5V. This is still below the TTL guaranteed high output minimum level of 2.8V, but noise margin is reduced. For best results with a 12V supply, use a logic family that provides a  $V_{OH}$  greater than 3V.

The digital input stages draw supply current whenever the digital input voltage is not at one of the supply rails. Driving the digital input signals from GND to V+ with a fast transition time minimizes power dissipation.

#### High-Frequency Performance

In  $50\Omega$  systems, signal response is reasonably flat even past 100MHz (see Figure 13). Figure 13 also illustrates that the frequency response is very consistent over varying analog signal levels.

An OFF switch acts like a capacitor and passes higher frequencies with less attenuation, resulting in signal feed-through from a switch's input to its output. Off Isolation is the resistance to this feed-through, while Crosstalk indicates the amount of feed-through from one switch to another. Figure 14 details the high Off Isolation and Crosstalk rejection provided by this family. At 10MHz, Off Isolation is about 55dB in  $50\Omega$  systems, decreasing approximately 20dB per decade as frequency increases. Higher load impedances decrease Off Isolation and Crosstalk rejection due to the voltage divider action of the switch OFF impedance and the load impedance.



#### Leakage Considerations

Reverse ESD protection diodes are internally connected between each analog-signal pin and both V+ and GND. One of these diodes conducts if any analog signal exceeds V+ or GND.

Virtually all the analog leakage current comes from the ESD diodes to V+ or GND. Although the ESD diodes on a given signal pin are identical and therefore fairly well balanced, they are reverse biased differently. Each is biased by either

V+ or GND and the analog signal. This means their leakages will vary as the signal varies. The difference in the two diode leakages to the V+ and GND pins constitutes the analog-signal-path leakage current. All analog leakage current flows between each pin and one of the supply terminals, not to the other switch terminal. This is why both sides of a given switch can show leakage currents of the same or opposite polarity. There is no connection between the analog signal paths and V+ or GND.

# Typical Performance Curves T<sub>A</sub> = +25°C, Unless Otherwise Specified

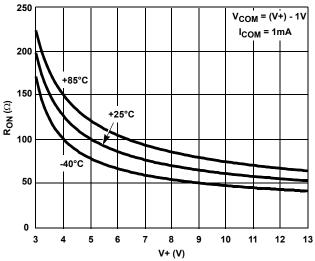


FIGURE 9. ON RESISTANCE vs SUPPLY VOLTAGE

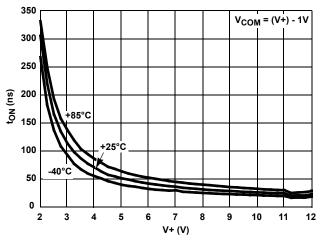


FIGURE 11. TURN - ON TIME vs SUPPLY VOLTAGE

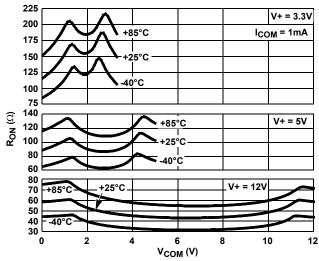


FIGURE 10. ON RESISTANCE vs SWITCH VOLTAGE

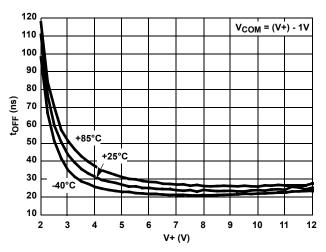


FIGURE 12. TURN - OFF TIME vs SUPPLY VOLTAGE

# **Typical Performance Curves** T<sub>A</sub> = +25°C, Unless Otherwise Specified (Continued)

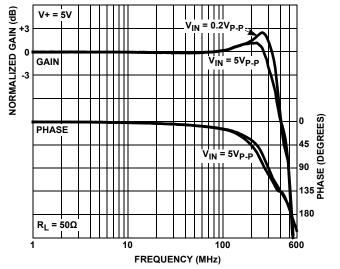


FIGURE 13. FREQUENCY RESPONSE

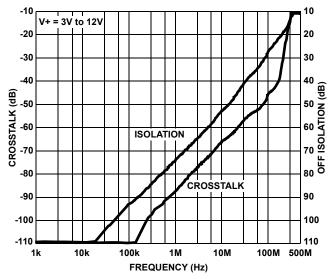


FIGURE 14. CROSSTALK AND OFF ISOLATION

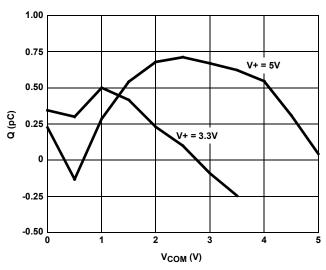


FIGURE 15. CHARGE INJECTION vs SWITCH VOLTAGE

# Die Characteristics

# SUBSTRATE POTENTIAL (POWERED UP):

**GND** 

#### TRANSISTOR COUNT:

ISL84524: 193 ISL84525: 193

# PROCESS:

Si Gate CMOS

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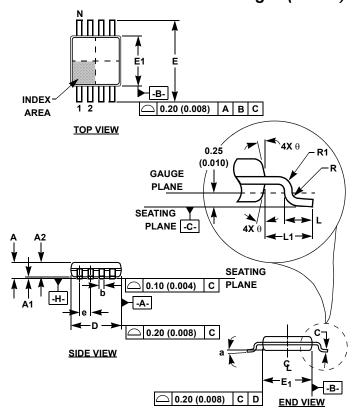
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# Mini Small Outline Plastic Packages (MSOP)



#### NOTES:

- These package dimensions are within allowable dimensions of JEDEC MO-187BA.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1994.
- Dimension "D" does not include mold flash, protrusions or gate burrs and are measured at Datum Plane. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E1" does not include interlead flash or protrusions and are measured at Datum Plane. -H- Interlead flash and protrusions shall not exceed 0.15mm (0.006 inch) per side.
- 5. Formed leads shall be planar with respect to one another within 0.10mm (.004) at seating Plane.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm (0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm (0.0027 inch).
- 10. Datums -A and -B to be determined at Datum plane
- 11. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only

# M10.118 (JEDEC MO-187BA) 10 LEAD MINI SMALL OUTLINE PLASTIC PACKAGE

INCHES MILLIMETERS					
	INC	пЕЗ	MILLIMILILIA		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
Α	0.037	0.043	0.94	1.10	-
A1	0.002	0.006	0.05	0.15	-
A2	0.030	0.037	0.75	0.95	-
b	0.007	0.011	0.18	0.27	9
С	0.004	0.008	0.09	0.20	-
D	0.116	0.120	2.95	3.05	3
E1	0.116	0.120	2.95	3.05	4
е	0.020	0.020 BSC		BSC	-
Е	0.187	0.199	4.75	5.05	-
L	0.016	0.028	0.40	0.70	6
L1	0.037	0.037 REF		REF	-
N	1	10		0	7
R	0.003	-	0.07	-	-
R1	0.003	-	0.07	-	-
θ	5 <sup>0</sup>	15 <sup>0</sup>	5 <sup>0</sup>	15 <sup>0</sup>	-
α	0°	6 <sup>0</sup>	0 <sub>0</sub>	6 <sup>0</sup>	-

Rev. 0 12/02

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MAX4968CEXB+ MAX4760EWX+T NLAS3799BMNR2G NLAS5123MNR2G NLAS5213AMUTAG NLAS7222AMTR2G
NLAS5213AUSG MAX14807ECB+ MAX4968ECM+ NLV14066BDG LC78615E-01US-H PI5A4599BCEX PI5A3157BZUEX
NLAS4717EPFCT1G PI5A3167CCEX MAX4744ELB+T MAX4802ACXZ+ SLAS3158MNR2G PI5A3157BC6EX PI5A392AQE
MAX4744HELB+T PI5A4157ZUEX MC74HC4067ADTR2G PI5A4158ZAEX PI5A3166TAEX MAX4901EBL+T MAX14510EEVB+T
PI3A3899ZTEX MAX4996ETG+T MAX4889AETO+T MAX14508EEVB+T MAX4701ETE+T MAX4996LETG+T NLX2G66FCTAG
TMUX136RSER